



## **Product Change Notice**

PCN Number: P222801		Revision: A		Date of Publication: 07/13/2022			
PRODUCT NAME	PRODUCT PART#	OLD — RE	<b>V. —</b> NEW		<b>REVISION T</b>	YPE	
CM-3455J	71811-IA	1.0	1.1	Hardware			
		1.00	1.10	BIOS			
EASON OF CHANG	E:						
Current Infineon SLB9	665TT2.0 Trust Mod	ule Platform (T	PM) is consti	rained creating e	extended manu	facturing l	ead tir
DESCRIPTION OF C	HANGE:						
Change to use Intel Pl	atform Truct Tochnol	omy (TCC TDM	2 0)				
indinge to use initer Pi		logy (ICG IPIN	2.0).				
MPACT OF CHANGI	F AND RECOMMEN						
		D Aonon.					
his change has been	thoroughly evaluate	d to ensure that	at there is no	quality, reliabili	ty or thermal ir	mplication	s to o
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	nding our customer t	o perform add	itional qualifi	cation of this ch	anges, except o	customer i	s usin
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APPROVED BY

VP OF SALES <APPROVED> 07/13/2022

Signature